

## FFAF20U120DN

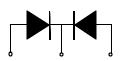
### **Features**

- · High voltage and high reliability
- · High speed switching
- Low forward voltage

### **Applications**

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- Power switching circuits





1. Anode 2. Cathode 3. Anode

### **ULTRA FAST RECOVERY POWER RECTIFIER**

## Absolute Maximum Ratings (per diode) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	1200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100 °C	20	А
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	120	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	0.84	°C/W

## Electrical Characteristics (per diode) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage					V
	I <sub>F</sub> = 20A	T <sub>C</sub> = 25 °C	-	-	3.5	
	I <sub>F</sub> = 20A	$T_C = 25  ^{\circ}C$ $T_C = 100  ^{\circ}C$	-	-	3.2	
I <sub>RM</sub> *	Maximum Instantaneous Reverse Current					
	@ rated V <sub>R</sub>	T <sub>C</sub> = 25 °C	-	-	20	μΑ
		$T_C = 25$ °C $T_C = 100$ °C	-	-	1.2	mA
t <sub>rr</sub>	Maximum Reverse Recovery Time		-	-	120	ns
I <sub>rr</sub>	Maximum Reverse Recovery Current		-	-	10	Α
Q <sub>rr</sub>	Maximum Reverse Recovery Charge		-	-	500	nC
	$(I_F = 20A, di/dt = 200A/\mu s)$					
W <sub>AVL</sub>	Avalanche Energy		1.0	-	-	mJ

<sup>\*</sup> Pulse Test: Pulse Width=300 µs, Duty Cycle=2%

## **Typical Characteristics**

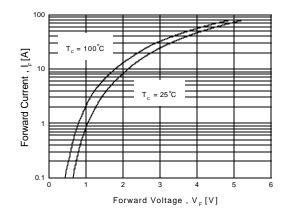
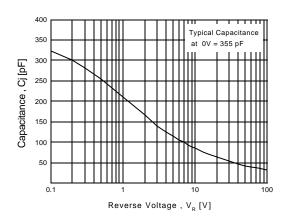


Figure 1. Typical Forward Voltage Drop vs. Forward Current



**Figure 3. Typical Junction Capacitance** 

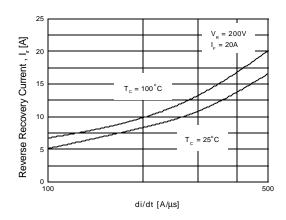


Figure 5. Typical Reverse Recovery Current vs. di/dt

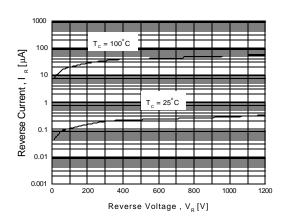


Figure 2. Typical Reverse Current vs. Reverse Voltage

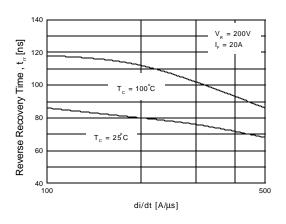


Figure 4. Typical Reverse Recovery Time vs. di/dt

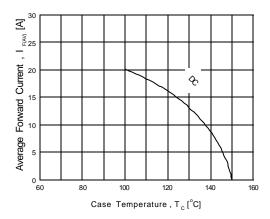
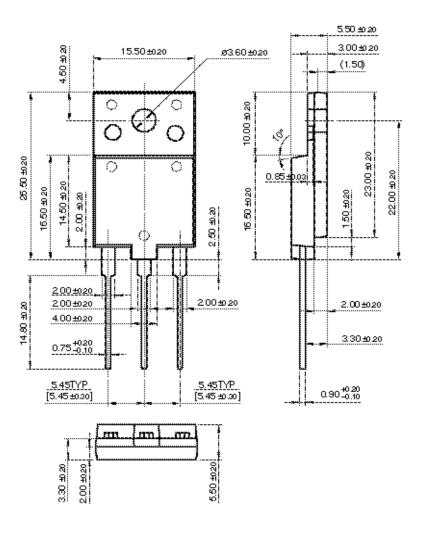


Figure 6. Forward Current Derating Curve

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# **Package Dimensions**

# TO-3PF



**Dimensions in Millimeters** 

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